IPC ASSOCIATION ELECTRONIC	Material Compo © Copyright 2005. II international and Pan	PC, Bannockb	urn, Illinois. A	all rights reserved un	nder both	This docume level parts, the	ent is a declar he declaration	ation of n encom	the substances passes all lowe	within the	e manufactur terials for w	er listed it hich the m	em. Note: i anufacture	if the item is an as r has engineering	sembly with lowe responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information					
Supplie	r Information														
Company name* Compan				ompany unique ID			Unique ID Authority					Response Date*			
onsemi												2024-04-19			
Contact N	lame	Title - Contact]	Phone - Contact*				Email - Contact*					
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Representative]	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	ite Ve	rsion	Manufacturing Site		V	Veight*	UOM	Unit Type
		UC3845I	C3845BNG ANA SMPS F		WM CONTROLLER		2024-04-19			CNW		4	82.16	mg	Each
Manufa	cturing Proccess Informat	ion													
	Terminal Plating / Grid Array Material Termi		rminal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperat		ure Max Time at Peak Temper		Temperati	ire Numl	ber of Reflow Cyc	eles		
	Matte Tin (Sn) - annealed		CU Alloy NA		VA.		0 C		30 seco		second	is 3			
Comments	S			·							·				·
		<u>'</u>		<u> </u>							·				<u> </u>
or more	information regarding material	composition	please refer to	page 3										·	

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.19	mg	Supplier	Silicon (Si)	7440-21-3		2.19	mg
Die Attach	8.92			Epoxy resin	proprietary data		0.223	mg
			Supplier	Silver (Ag)	7440-22-4		7.136	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.5798	mg
			Supplier	Acrylic resins	Proprietary Data		0.9812	mg
Lead Frame	139.78		Supplier	Silver (Ag)	7440-22-4		0.9785	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2796	mg
			Supplier	Iron (Fe)	7439-89-6		3.6343	mg
			Supplier	Copper (Cu)	7440-50-8		134.8877	mg
Mold Compound-Black	317.53		Supplier	Carbon Black (C)	1333-86-4		1.5876	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		277.8387	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		19.0518	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		19.0518	mg
Plating	13.56	mg	Supplier	Tin (Sn)	7440-31-5		13.56	mg
Wire Bond - Au	0.18	mg	Supplier	Gold (Au)	7440-57-5		0.18	mg